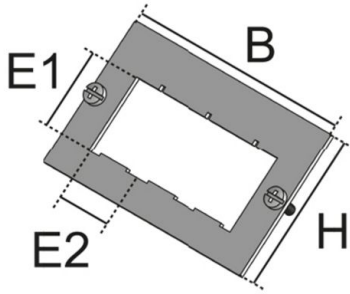


UDEP COR

installation board, data technology

Installation board made of aluminium, coated black. To be screwed into a data device carrier. For data jacks.



material	Aluminium, coated black on one side
type of assembly	screwable
application area	Device carrier
Recess for manufacturer	Corning: LANscape S250 module RJ45 Kat. 6 Corning: LANscape S500 module RJ45 Kat. 6A

Aluminium

Product	H	B	E1	E2	data jacks	G
UDEP-COR 3	46 mm	75 mm	22,8 mm	18 mm	3	0,03 kg

H: height

B: width

E1: fitting dimension

E2: fitting dimension

data jacks: Maximum number of installable data jacks

G: weight

OPTIONAL ACCESSORIES

UGETD

